



We,

Axelera AI B.V., a company registered in the Netherlands with company number 82483027, whose registered office is located at: High Tech Campus 5, 5656 AE Eindhoven, the Netherlands

Certify that the products listed in the Appendix I of this declaration are in conformity with the relevant Union harmonization legislation as listed below:

- **EU EMC Directive of 2014/30/EU and UK Electromagnetic Compatibility Regulations 2016 :**

where the following standards were applied

- EU/UK Standards:
 - EN 55032:2015 + A11:2020, Class A
 - EN 55032:2015 + A11:2020
 - CISPR 32:2015 + COR1:2016
 - EN 55032:2015 + A1:2020, Class A
 - EN 55032:2015 + A1:2020
 - CISPR 32:2015 + A1:2019
 - EN 61000-3-2:2014
 - EN IEC 61000-3-2:2019 + A1:2021
 - EN 61000-3-3:2013 + A2:2021
 - BS EN 61000-3-2:2014
 - BS EN IEC 61000-3-2:2019 + A1:2021
 - BS EN 61000-3-3:2013 + A2:2021
- IEC Standards:
 - IEC 61000-4-2:2008
 - IEC 61000-4-3:2020
 - IEC 61000-4-4:2012
 - IEC 61000-4-4:2012 + A1:2017
 - IEC 61000-4-5:2014
 - IEC 61000-4-6:2023
 - IEC 61000-4-11:2020 + COR2:2022

- **Low Voltage Directive 2014/35/EU and UK Electrical Equipment (Safety) Regulations 2016:**

where the following standards were applied:

- IEC 62368-1:2014
- EN 62368-1:2014 + A11:2017
- BS EN 62368-1:2014 + A11:2017

- **RoHS Compliance:** the product is in compliance with the European Union Directive 2011/65/EU and (EU) 2015/863 and UK ROHS 2012 on the Restriction of the use of certain Hazardous Substances in electronic equipment (RoHS).

RoHS Restricted Substances	Allowable Limit
Cadmium and its compounds	100 ppm (0.01 weight %)
Mercury and its compounds	1000 ppm (0.1 weight %)
Hexavalent chromium and its compounds	1000 ppm (0.1 weight %)
Lead and its compounds	1000 ppm (0.1 weight %)
Polybrominated biphenyls (PBB)	1000 ppm (0.1 weight %)
Polybrominated diphenyl ethers (PBDE)	1000 ppm (0.1 weight %)



Bis (2-ethylhexyl) phthalate (DEHP)	1000 ppm (0.1 weight %)
Butyl benzyl phthalate (BBP)	1000 ppm (0.1 weight %)
Dibutyl phthalate (DBP)	1000 ppm (0.1 weight %)
Diisobutyl phthalate (DIBP)	1000 ppm (0.1 weight %)

- Note this product is subject to RoHS exemptions as specified in the applicable directives. The exemptions claimed include: 7a, 7c-l.
- **Halogen-Free Compliance:** the product meets the IEC 61249-2-21 standard for Halogen-Free materials, with chlorine (Cl) and bromine (Br) content individually below 900 ppm, and a combined total of chlorine and bromine below 1500 ppm with the exceptions indicated in Appendix II.
- **REACH compliance:** the product complies with EU Regulation (EC) No.1907/2006, also known as REACH regulation (The Registration, Evaluation, Authorization, and Restriction of Chemicals) and meets the restrictions outlined in Annex XVII (Restrictions on certain hazardous substances, mixtures, and articles). For reference, the list of restricted substances under REACH Annex XVII is available at the European Chemicals Agency (ECHA): <https://echa.europa.eu/substances-restricted-under-reach>. We also confirm that the product does not contain any Substances of Very High Concern (SVHC) as listed in the Candidate List published by the European Chemicals Agency (ECHA), except for those specifically indicated in Appendix II of this document. With the exception of the substances listed in Appendix II, this product remains below the 0.1% weight by weight (0.1 wt%) threshold for SVHC substances, in accordance with Article 33 of the REACH regulation.

Signed on behalf of Axelera AI B.V

A handwritten signature in black ink, appearing to read 'Fabrizio Del Malffeo'.

13-05-2026 | 18:03 CEST

Fabrizio Del Malffeo

CEO and Founder

Eindhoven, the Netherlands



Appendix I – List of products and Axelera part numbers

- Metis M.2 Card:
 - AXE-BME20M1AM01A02
 - AXE-BME20M1AR01B02
- Metis 1-chip PCIe Card:
 - AXE-BME20P1AJ04A02 (excluding heatsink)
 - AXE-BME20P1AE16A02 (excluding heatsink)
- Metis Compute Board
 - AXE-BME20S1#####
- Metis 4-chip PCIe Card:
 - AXE-BME20P4#####



Appendix II – Exceptions

Metis 1-chip PCIe Card (AXE-BME20P1AJ04A02, AXE-BME20P1AE16A02)

List of SVHC Substances Present Above 0.1 wt%

Substance Name	CAS Number	Usage/Location
Lead (Pb)	7439-92-1	Die Attach Material
Diboron trioxide (B ₂ O ₃)	1303-86-2	Some thick film chip resistors contain B ₂ O ₃ , which merges with other constituents during high-temperature processing, forming glass

Metis Compute Board (AXE-BME20S1#####)

The following components have been identified as containing halogen concentrations above the voluntary halogen-free thresholds defined in IEC 61249-2-21:

Component	Halogen type	Concentration (ppm)	Halogen-Free Thresholds (ppm) IEC 61249-2-21
WAFER HD 4P S/T 2.54MM L-GRAY//LINGYANG/WF2541W-D036-04E800B	Bromine	70,103.8	< 900
HEADER 2X20P G/F 2.0 BLK S/T//PINREX/220-97-20GB01	Bromine	89,546	< 900
	Total halogens (Br + Cl + F + I)	159,649.8	< 1,500

The above components, specifically connector housing, contain brominated flame retardants for fire safety in compliance with UL 94 V-0 requirements. These flame retardants are not PBB, PBDE, or HBCDD, and are not restricted under RoHS, EU POP, or REACH Annex XVII.

All listed components remain fully compliant with EU Directive 2011/65/EU (RoHS). Non-compliance is limited to voluntary IEC 61249-2-21 or JEDEC JS709 halogen-free thresholds only.

Customers with strict halogen-free procurement requirements should contact Axelera AI.